

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re U.S. Patent Application of:

INVENTOR(S): Radenne et al.

SERIAL NO.: 10/

ART UNIT:

FILED: Herewith

EXAMINER:

TITLE: Method for Encapsulation of a Chipcard and Module Obtained Thus

ATTORNEY DOCKET NO.: 003D.0032.U1(US)

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

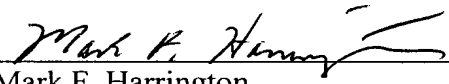
## INFORMATION DISCLOSURE STATEMENT

Dear Sir:

Pursuant to Sections 609 and 707.05(b) of the MPEP and 37 CFR 1.97-1.99, the attached form PTO-1449 lists documents, which may be pertinent to the invention as claimed in the above-identified application. A copy is herewith submitted of the non-US documents. The documents include art cited in International and French Search Reports issued in the parent International application. Copies of the Search Reports are also enclosed.

The citation of these documents should not be construed as a representation that a thorough search has been made, or that other, more pertinent material is not available.

Respectfully submitted,

  
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